

DESCRIPTION

The SPN11T11 is the N-Channel logic enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. The SPN11T11 has been designed specifically to improve the over all efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

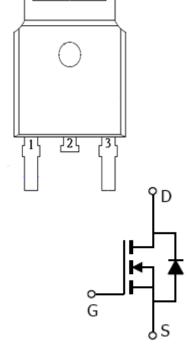
APPLICATIONS

- Powered System
- DC/DC Converter
- Load Switch

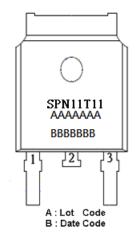
FEATURES

- 110V/12A, RDS(ON)= $108m\Omega$ @VGS=10V
- 110V/12A, RDS(ON)= $137m\Omega$ @VGS=4.5V
- ♦ High density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L, package design

PIN CONFIGURATION TO-252-2L



PART MARKING



PIN DESCRIPTION					
Pin	Symbol	Description			
1	G	Gate			
2	D	Drain			
3	S	Source			

ORDERING INFORMATION

Part Number	Package	Part Marking		
SPN11T11T252RGB	TO-252-2L	SPN11T11		

[※] SPN11T11T252RGB: Tape Reel; Pb − Free; Halogen - Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		Vdss	110	V
Gate –Source Voltage		VGSS	±20	V
Continuous Drain Current(TJ=150°C)	Tc=25°C	- Id	12	A
, , , , , , , , , , , , , , , , , , ,	Tc=70°C		8.0	
Pulsed Drain Current		IDM	24	A
Avalanche Current		IAS	14	A
Power Dissipation @ Tc=25°C		PD	40	W
Operating Junction Temperature		ΤJ	150	°C
Storage Temperature Range		Tstg	-55/150	°C
Thermal Resistance-Junction to Ambient		RθJA	110	°C/W



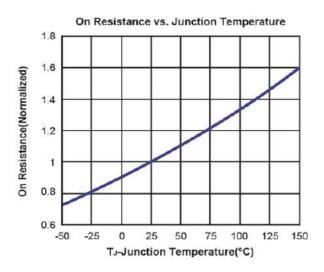
ELECTRICAL CHARACTERISTICS

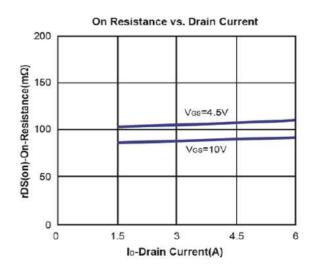
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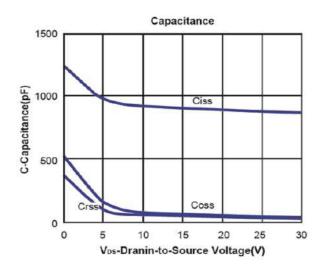
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static		1				
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=250uA	110			V
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1		3	
Gate Leakage Current	Igss	VDS=0V,VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	Vds=80V,Vgs=0V			1	uA
On-State Drain Current	ID(on)	VDS\geq5V,VGS=10V	12			A
Drain-Source On-Resistance	RDS(on)	Vgs=10V,Id=5A		90	108	mΩ
	TCDS(OII)	Vgs=4.5V,Id=3A		105	137	mΩ
Diode Forward Voltage	Vsd	Is=1A,VGS =0V		0.9	1.2	V
Dynamic						
Total Gate Charge (10V)	Qg	-Vds=50V, Id=5A		22.3		nC
Total Gate Charge (4.5V)	Qg			11.9		
Gate-Source Charge	Qgs			4.8		
Gate-Drain Charge	Qgd			6.4		
Input Capacitance	Ciss			895		pF
Output Capacitance	Coss	V _{DS} =15V, V _{GS} =0V f=1MHz		56		
Reverse Transfer Capacitance	Crss			43		
Turn-On Time	td(on)			13.3		nS
	tr	VDD=50V, ID=5A,		25.4		
Turn-Off Time	td(off)	VGEN= $10V$, RG= 1Ω		27.5		
	tf			16.2		

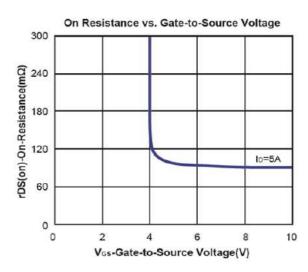


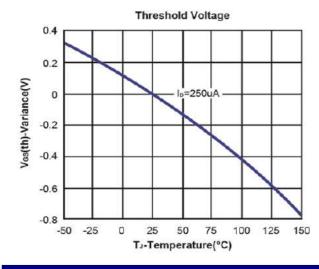
TYPICAL CHARACTERISTICS

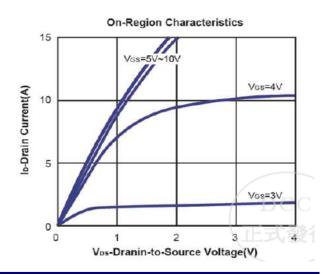




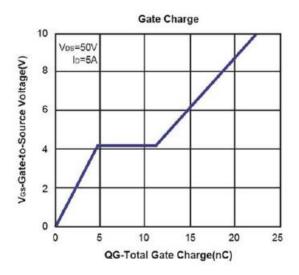


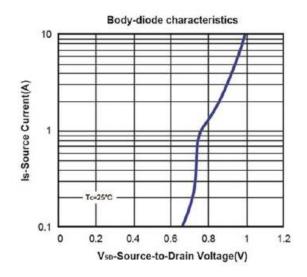






TYPICAL CHARACTERISTICS





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